Shoulder 好达 SHOULDER ELECTRONICS CO., LTD.

CERAMIC RESONATOR Data Sheet

PRODUCT 产品: CERAMIC RESONATOR

MODEL NO 型号: ZTACS....MX

PREPARED 编 制: Fengyu

CHECKED 审核: York

APPROVED 批 准:

DATE 日期: 2007-01-25

1. Scope

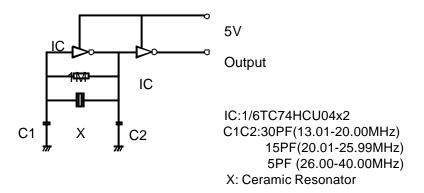
The specification is fit for ceramic resonator 13.01-50.00MHz.

2. Part NO: ZTACS .. MX

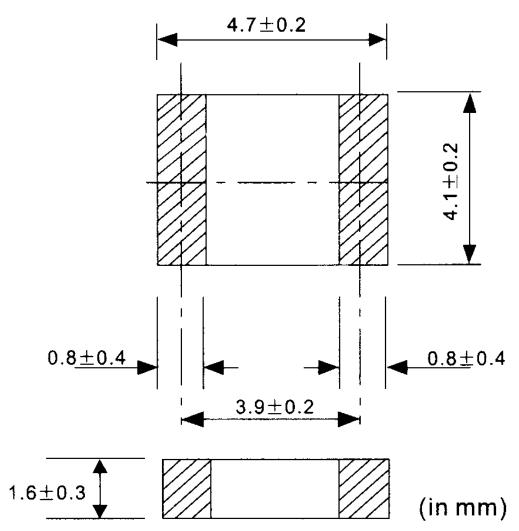
3. Electrical Characteristics

No.	ltem	Characteristics				
3-1	Oscillate Frequency (MHz)	13.01-50.00				
3.2	Frequency Tolerance max	±0.5%				
3.3	Resonant Impedance max (Ω)	40				
3.4	Built – in Capacitance (PF)					
3.5	Insulate Resistance min (M Ω)	100				
3.6	Withstanding Voltage D.C (V)	100 (max 5 sec)				
3.7	Voltage (1) D.C Voltage max (V) (2) Input Voltage max (V)	6 15Vp-p				
3.8	Temp characteristics of Oscillate frequency max	±0.3%				
3.9	Operating Temp Range(℃)	-20 ~ +80				
3.10	Storage Temp (°C)	-55 ~ +85				

4. Test Circuit



5. Dimension



6. Physical and Environmental Characteristics

No	ltem	Condition of Test	Performance Requirements			
6.1	Humidity	Keep the resonator at $40\pm2^{\circ}C$ and 90-95% RH for 96 \pm 4 hours. Then release the resonator into the room condition for 1 hour prior to the measurement.	It shall fulfill the specifications in Table 1.			
6.2	Vibration	Subject the resonator to vibration for 2 hours each in x,y and z axis with the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10-55Hz	specifications in Table			
6.3	Mechanical Shock	Drop the resonator randomly onto a concrete floor from the height of 100 cm 3 times.	It shall fulfill the specifications in Table 1.			

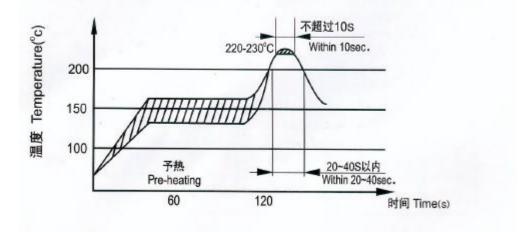
6.4	Soldering Test	Passed through the the following conditio temperature for measurement.	It shall fulfill the specifications in Table 1.	
		surface of the substrate	substrate	
		Preheat 150±5℃		
		Peak 240±5℃	10 ± 3 sec.	
6.5	Solder Ability	Dip the resonator solder bath at 230±5	More than 95% of the terminal surface shall be covered.	
6.6	High Temperature Exposure	Subject the resonator ± 4 hours. Then release into the room condition to the measurement.	It shall fulfill the specifications in Table 1.	
6.7	Low Temperature	Subject the resonator ± 4 hours. Then relation the room condition to the measurement.	It shall fulfill the specifications in Table 1.	
6.8	Temperature Cycling	Subject the resonato minutes followed by of 85 °C for 30 min repeated 5 times with 15 second at the ro hour prior to the meas	It shall fulfill the specifications in Table 1.	

TABLE1

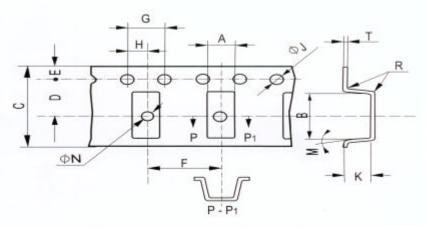
Item	Specification							
Oscillation Frequency Change	∆F/Fo≪0.3% max							
Resonant Impedance	∆Ro≪±10 Ohm							

7.

RECOMMENDED REFLOW SOLDERING STANDARD CONDITIONS



8. Packing



Tape Dimension (mm)

	A ±0.2	В ±0.2	С ±0.3	D ±0.1	Е ±0.1	F ±0.1	G ±0.1	H 土0.1	ØJ ±0.1	ØN ±0.1	M max	R max	К ±0.2	T 土0.1
MG	3.8	7.8	16.0	7.5									2.1	
MT	5.0	4.4	12.0	5.5	1.75	8.0	4.0	2.0	1.5	1.6	10"	0.3	1.8	0.3
MX	3.4	4.0	12.0	5.5									1.3	

Standard Package: 1Kpcs / reel